SCOPE:

This specification applies to the Pb Free high current type SMD inductors for

MSCDB-1303-SERIES

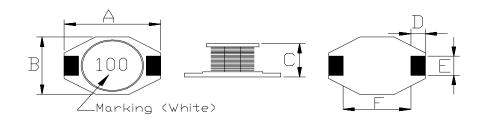
Warn:It is here not to use synchronous rectification curcuit!

PRODUCT INDENTIFICATION

MSCDB - 1303 - 100 M

- 1
- (2)
- 3 4
- **1** Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 13.5 Max. mm

B: 9.50 Max. mm

C: 3.20 Max. mm

D: 2.54 Typ. mm

E: 2.54 Typ. mm

F: 7.62 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature +60°C Max.

(3)-2 Operate temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$

(Including self temp. rise)



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated D	C Current		
PT/NO.	L(µH)	Tolerance Frequency		RDC(Ω)Max.	IDC1(A)	IDC2(A)	Marking	
MSCDB-1303-2R2	2.2	M,N	100kHz/0.25V	30m	3.8	4.4	2R2	
MSCDB-1303-4R7□	4.7	N	100kHz/0.25V	60m	2.7	3.2	4R7	
MSCDB-1303-6R8	6.8	M,N	100kHz/0.25V	75m	2.6	3.0	6R8	
MSCDB-1303-100□	10	M,N	100kHz/0.25V	90m	2.4	2.3	100	
MSCDB-1303-150□	15	M,N	100kHz/0.25V	0.12	2.0	1.9	150	
MSCDB-1303-220	22	M,N	100kHz/0.25V	0.19	1.6	1.5	220	
MSCDB-1303-330□	33	M,N	100kHz/0.25V	0.25	1.4	1.2	330	
MSCDB-1303-470□	47	M,N	100kHz/0.25V	0.32	1.0	1.0	470	
MSCDB-1303-680□	68	M,N	100kHz/0.25V	0.55	0.9	0.9	680	
MSCDB-1303-101□	100	K,M	100kHz/0.25V	0.70	0.7	0.73	101	
MSCDB-1303-151□	150	K,M	100kHz/0.25V	1.00	0.6	0.62	151	
MSCDB-1303-221	220	K,M	100kHz/0.25V	1.60	0.5	0.51	221	
MSCDB-1303-331□	330	K,M	100kHz/0.25V	2.20	0.4	0.40	331	
MSCDB-1303-471□	470	K,M	100kHz/0.25V	3.30	0.3	0.33	471	
MSCDB-1303-681□	680	K,M	100kHz/0.25V	4.40	0.2	0.28	681	
MSCDB-1303-102	1000	K,M	100kHz/0.25V	7.00	0.1	0.23	102	

※ ☐ specify the inductance tolerance,K(±10%),M(±20%),N(±30%)

※ IDC1: Based on inductance change (△L/Lo: ≤drop 10%)@ambient temperature 25°C

IDC2: Based on temperature rise (△T: 40°C TYP.)

Rated DC Current: The less value which is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		in figure 1 and a load applied unitil the figure in the arrow		
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)		
	no mechanical	PCB dimension shall the page 7/9		
	damage or elec-	F(Pressurization)		
	trical damege.	П		
		R5 45±2 45±2 10 20 R340		
		PRESSURE ROD figure-1		
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		and when a vibration having an amplitude of 1.52mm		
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should		
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.		
	damage.	(A total of 6 hours)		
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated		
	More than 90%	over the whole of the sample before hard, the sample shall		
		then be preheated for about 2 minutes in a temperature of		
		130∼150°C and after it has been immersed to a depth 0.5mm		
		below for 3±0.2 seconds fully in molten solder M705 with		
		a temperature of 245±5℃.		
		More than 90% of the electrode sections shall be couered		
		with new solder smoothly when the sample is taken out of		
		the solder bath.		



MECHANICAL

TEST ITEM	SPECIFICATION				
TEST ITEM Resistance to Soldering heat reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 260±3° 10 sec 250 Pre-heating 150 - 180° 2 min 10 sec, 2 min or more The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.			

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM			SPECIFICATION				
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperatu	a temperature of 85±2℃ and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal					
	damage.	humidity fo	r 1 hour.				
Low temperature	∆L/Lo≦±5%	-	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a temperature of -25±3℃.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical		after the sample has been left in a normal temperature and				
	damage.	normal hun	normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The sample	The sample shall be subject to 5 continuos cycles, such as shown				
temperature		in the table	in the table 2 below and then it shall be subjected to standard				
	There shall be	atmospheri	atmospheric conditions for 1 hour, after which measurement				
	no other dama-	shall be ma	shall be made.				
	ge of problems						
		table 2					
			Temperature	Duration			
		1	−25±3 °C	30 min.			
			(Themostat No.1)				
		2	Standard	No.4 - No.2			
		-	atmospheric	No.1→No.2			
		3	85±2℃	30 min.			
			(Themostat No.2)	JU IIIIII.			
		4	Standard				
			atmospheric	No.2→No.1			
Moisture storage	^L/Lo≤±5%	The sample	shall be left for 96+4 bour	rs in a temperature of			
			The sample shall be left for 96±4 hours in a temperature of				
	There shall be	40±2℃ and a humidity(RH) of 90~95%. Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and					
			normal humidity more than 1 hour.				
	damage.	normai nun	nany more than 1 nour.				

The sample shall be reflow soldered onto the printed circuit board in every test.

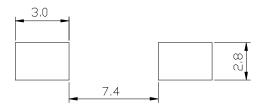


(5) LAND DIMENSION (Ref.)

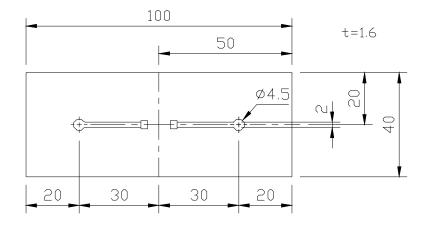
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit:mm



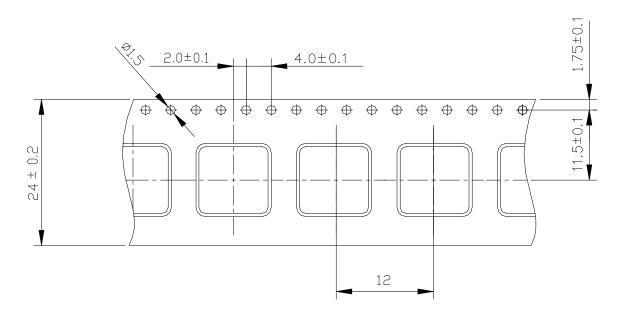
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



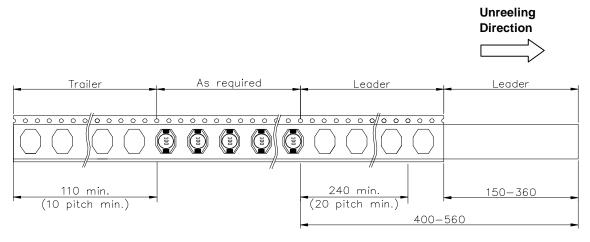


(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

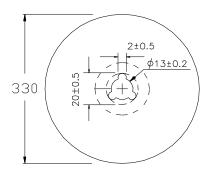


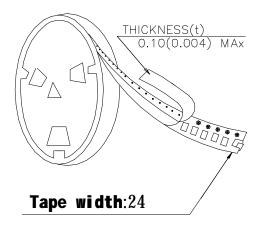
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1000pcs/Reel

The products are packaged so that no damage will be sustained.